



30V SYNCHRONOUS N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI3333-8 (Type D)

Product Summary

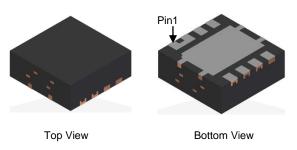
Device	ce BV _{DSS} R _{DS(ON)} Max		
Q1	30V	14.3m Ω @ V _{GS} = 8V, I _D = 4A	
Q2	30V	14.3m Ω @ V _{GS} = 8V, I _D = 4A	

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Analog Switch

PowerDI3333-8 (Type D)

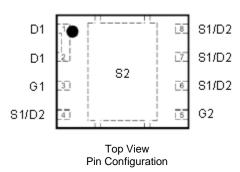


Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI[®]3333-8 (Type D)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.044 grams (Approximate)



Ordering Information (Note 4)

	Part Number	Case	Packaging			
	DMN3013LDG-7	PowerDI3333-8 (Type D)	1,000/Tape & Reel			
	DMN3013LDG-13	PowerDI3333-8 (Type D)	3,000/Tape & Reel			
Notes:	1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.					

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



R07 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1	Q2	Unit	
Drain-Source Voltage	V _{DSS}	30		V	
Gate-Source Voltage	V _{GSS}	10		V	
	T _C = +25°C T _C = +70°C	ID	15 12		A
Continuous Drain Current @ V _{GS} = 5V	T _A = +25°C T _A = +70°C	ID	9.5 7.6		A
Continuous Source-Drain Diode Current (Note 5)	ls	2.7	2.7	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	80	80	A
Avalanche Current (Note 6) L = 0.1mH		las	24	24	A
Avalanche Energy (Note 6) L = 0.1mH		E _{AS}	28	28	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Tatal Dowar Dissinction	T _A = +25°C	D	2.16	w	
Total Power Dissipation	T _A = +70°C	PD	1.25		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	58.8	°C/W	
mermai Resistance, Junction to Ampient (Note 5)	t<10s	$R_{\theta JA}$	34		
Thermal Resistance, Junction to Case		R _{θJC}	6.9		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	—	_	1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	—	—	100	nA	$V_{GS} = 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.75	0.95	1.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		—	10.9	14.3	mΩ	$V_{GS} = 8V, I_D = 4A$
Static Drain-Source On-Resistance	R _{DS(ON)}	—	13.3	16.1	mΩ	$V_{GS} = 4.5V, I_D = 4A$
		—	15.3	17.7	mΩ	$V_{GS} = 3.5V, I_D = 4A$
Forward Transfer Admittance	Y _{FS}	—	13	_	S	V _{DS} = 15V, I _D =4A
Diode Forward Voltage	V _{SD}	—	0.8	1.0	V	$V_{GS} = 0V, I_S = 4A$
DYNAMIC CHARACTERISTICS (Note 8)						-
Input Capacitance	C _{iss}	—	387	600		$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz
Output Capacitance	C _{oss}	—	219	350	pF	
Reverse Transfer Capacitance	C _{rss}	—	10.4	16		
Gate Resistance	R _G	—	3.3	6.8	Ω	$V_{DS} = 0V, V_{GS} = 0V,$ f = 1.0MHz
Total Gate Charge ($V_{GS} = 4.5V$)	Q _G	—	3.3	5.7		
Total Gate Charge at V _{TH}	Q _{G(TH)}	—	0.37	_		
Gate-Source Charge	Q _{GS}	—	0.6	_	nC	$V_{DS} = 15V, I_D = 4A$
Gate-Drain Charge	Q _{GD}	_	0.6	_]	
Turn-On Delay Time	t _{D(ON)}	—	4.2	6.3		$V_{DD} = 15V, V_{GS} = 4.5V,$ $I_D = 4A, R_G = 2\Omega$
Turn-On Rise Time	t _R	_	6.2	_]	
Turn-Off Delay Time	t _{D(OFF)}	—	9.7	15	ns	
Turn-Off Fall Time	t _F	—	2.0	_	1	
Reverse Recovery Time	t _{RR}	—	11.7	_	ns	$V_{DS} = 15V, I_F = 4A,$
Reverse Recovery Charge	Q _{RR}	—	7.5	_	nC	$di/dt = 300A/\mu s$

5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

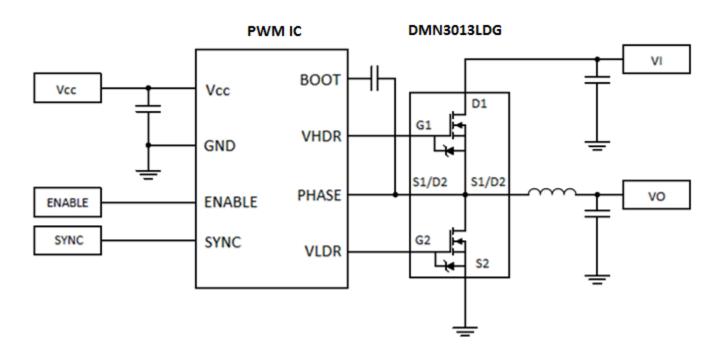


Electrical Characteristics Q2 (@T_A = +25°C, unless otherwise specified.)

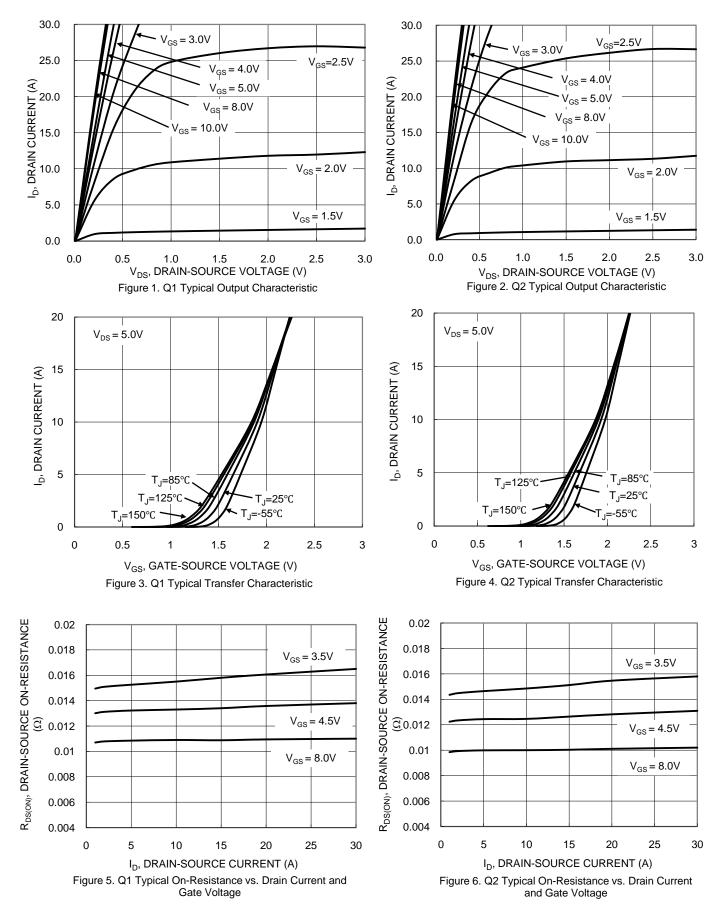
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						÷
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	_	V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	-	—	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	—	100	nA	$V_{GS} = 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.75	0.95	1.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		—	10.2	14.3	mΩ	$V_{GS} = 8V, I_D = 4A$
Static Drain-Source On-Resistance	R _{DS(ON)}	—	12.7	16.1	mΩ	$V_{GS} = 4.5V, I_D = 4A$
		_	14.8	17.7	mΩ	$V_{GS} = 3.5V, I_D = 4A$
Forward Transfer Admittance	Y _{FS}		13	_	S	V _{DS} =15V, I _D =4A
Diode Forward Voltage	V _{SD}	—	0.8	1.0	V	$V_{GS} = 0V, I_S = 4A$
DYNAMIC CHARACTERISTICS (Note 8)	·		•			
Input Capacitance	Ciss	—	397	600	pF	
Output Capacitance	C _{oss}	—	217	350	pF	− V _{DS} = 15V, V _{GS} = 0V, − f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	10.4	16	pF	
Gate Resistance	R _G	-	3.3	6.8	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Q _G	-	3.4	5.7	nC	
Total Gate Charge at V _{TH}	Q _{G(TH)}	-	0.39	_	nC	
Gate-Source Charge	Q _{GS}	—	0.6	—	nC	$V_{DS} = 15V, I_D = 4A$
Gate-Drain Charge	Q _{GD}	_	0.6	_	nC	7
Turn-On Delay Time	t _{D(ON)}	_	4.4	6.3	ns	
Turn-On Rise Time	t _R		6.7	_	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	_	10.4	15	ns	$I_D = 4A, R_G = 2\Omega$
Turn-Off Fall Time	t _F		2.2		ns	7
Reverse Recovery Time	t _{RR}	—	11.8	—	ns	
Reverse Recovery Charge	Q _{RR}	_	7.8	_	nC	$V_{DS} = 15V, I_F = 4A, di/dt = 300A/\mu s$

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

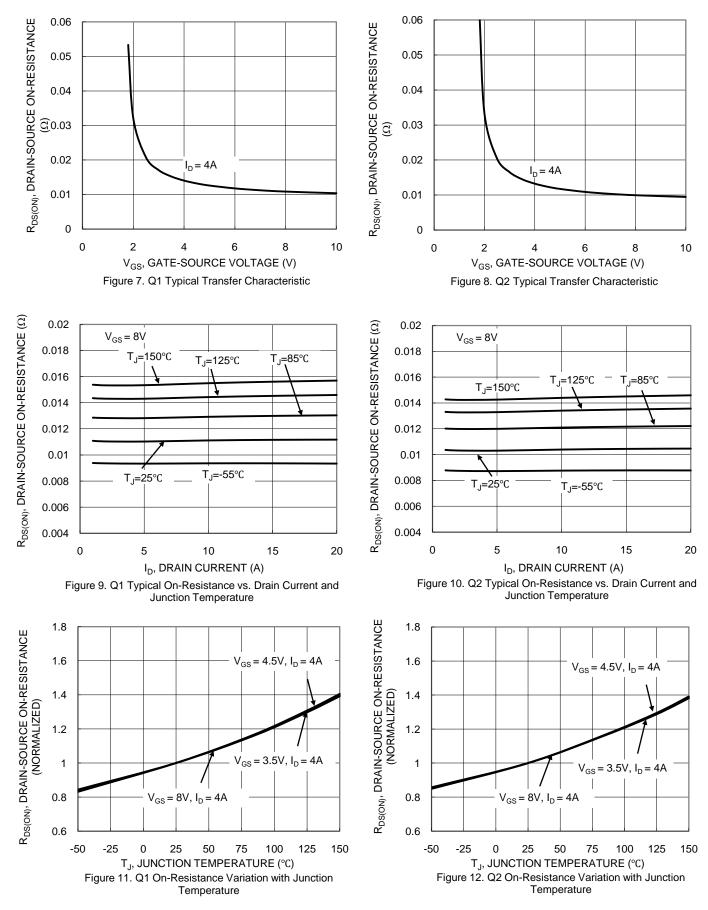
Typical Circuit





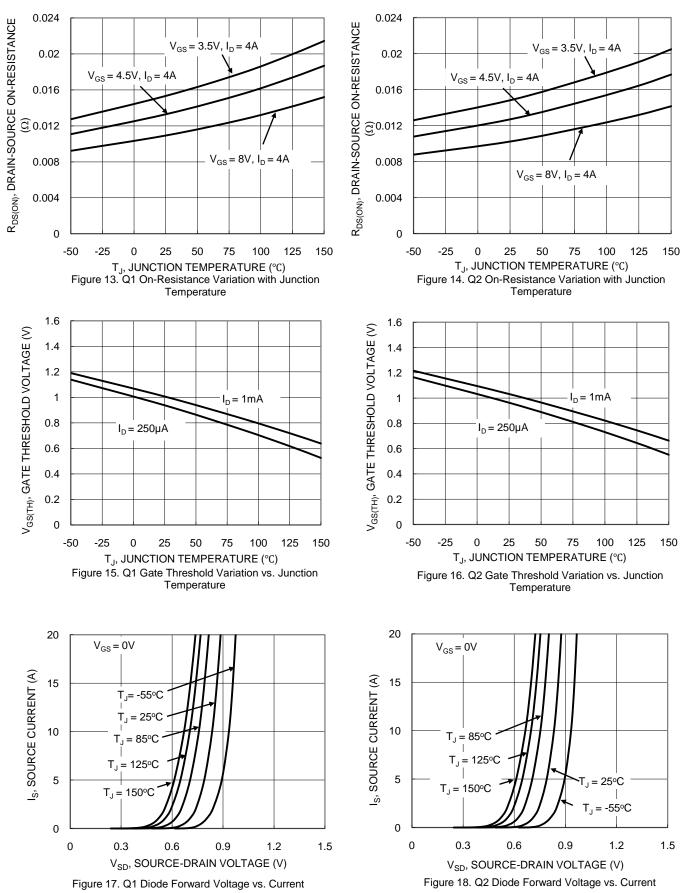




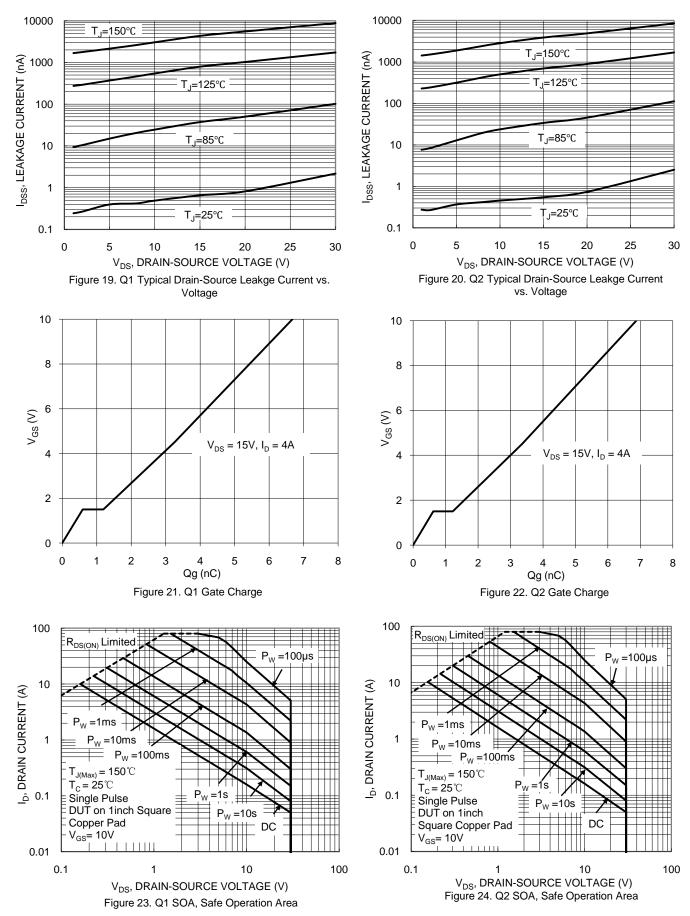


DMN3013LDG Document number: DS40579 Rev. 2 - 2

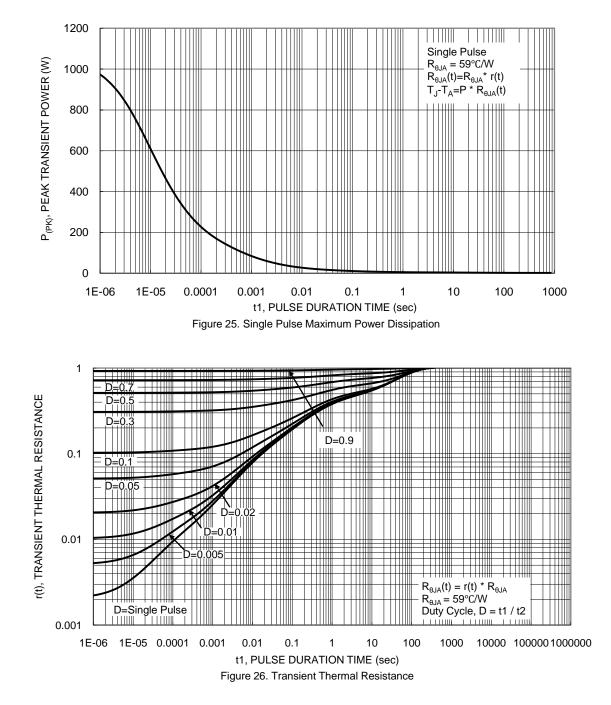










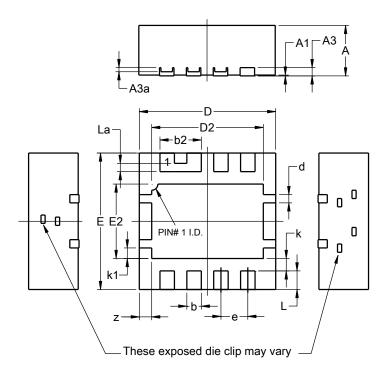




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type D)

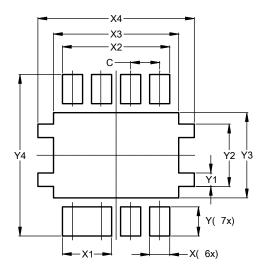


PowerDI3333-8 (Type D)									
Dim	Min	Max	Тур						
Α	1.17	1.23	1.20						
A1	0.00	0.05	0.02						
A3	0.15	0.25	0.20						
A3a	0.05	0.15	0.10						
b	0.30	0.40	0.35						
b2	0.95	1.05	1.00						
D	3.20	3.40	3.30						
D2	2.65	2.75	2.70						
ш	3.20	3.40	3.30						
E2	1.75	1.85	1.80						
d	0.15	0.25	0.20						
e			0.65						
k			0.30						
k1	0.21	0.31	0.26						
L	0.40	0.50	0.45						
La	0.15	0.25	0.20						
z	0.25	0.35	0.30						
All	Dimens	ions in	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type D)



Dimensions	Value (in mm)		
•			
С	0.650		
Х	0.450		
X1	1.100		
X2	2.400		
X3	2.800		
X4	3.500		
Y	0.650		
Y1	0.300		
Y2	1.390		
Y3	1.900		
Y4	3.600		



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